

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to:

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450 On

TOWNSEND and TOWNSEND and CREW LLP By:

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of:

Examiner:

Monica Lewis

Maria Cristina B. Estacio

Art Unit:

2822

Application No.: 09/805,597

DECLARATION UNDER 37 C.F.R. § 1. 131

Filed: March 12, 2001

SEMICONDUCTOR DEVICE

INCLUDING STACKED DIES MOUNTED ON

A LEADFRAME (AS AMENDED)

Sir:

For:

I Maria Cristina B. Estacio declare as follows:

- 1. I am aninventor in the referenced patent application.
- In the current Office Action, claims 1-4, 7 and 8 are rejected Pavier (U.S. 2002/0096748) as a primary reference.
- 3. The inventions of at least the pending claims were conceived of before January 19, 2001, the earliest noted priority date for Pavier. Evidence of conception is shown by Exhibit A which includes a fax cover sheet dated January 2, 2001 and an accompanying faxed page with Figures 1-3. This two page fax was faxed to me from a patent attorney when the present application was being prepared. A copy of a confirmation sheet for the faxed pages dated January 3, 2001 is also attached. Figures 1-3 in Exhibit A are the same Figures 1-3 that are used in the present patent application and show that embodiments of the invention were conceived of at least as early as January 2 or 3, 2001, which is prior to the earliest possible filing date for Pavier.
- 4. As shown by Exhibit A, I believe that embodiments of the pending claims were conceived of before January 19, 2001, the earliest U.S. filing date for Pavier, and that a patent application was diligently pursued thereafter.
- 5. The acts relied on in this Declaration (and described in the Exhibit) took place in a WTO country.
- 6. I hereby declare that all statements made of my own knowledge are true and that all statements made on information and belief are believed to be true. I understand that willful false statements and the like are punishable by fine or imprisonment, or both (18 U.S.C. §1001) and may jeopardize the validity of the application or any patent issuing thereon.

Pataw

February 4,2004